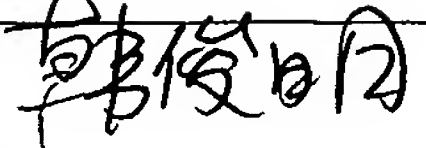
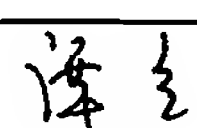
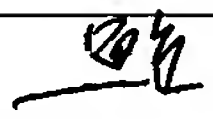


		<p>I hereby acknowledge the duty to disclose information that is known by me to be material to patentability as defined by 37 C.F.R. § 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the PCT international filing date of the continuation-in-part application.</p> <p>I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.</p>
VIII-4-1-1-1	Name (LAST, First)	XIANG, Wei
VIII-4-1-1-2	Residence: (city and either US State, if applicable, or country)	Guangdong, China
VIII-4-1-1-3	Mailing address:	CIMC R&D Center, No. 2 Gangwan Avenue, Shenzhen 518067 Guangdong China Guangdong China
VIII-4-1-1-4	Citizenship:	CN
VIII-4-1-1-5	Inventor's Signature: (if not contained in the request, or if declaration is corrected or added under Rule 26ter after the filing of the international application. The signature must be that of the inventor, not that of the agent)	
VIII-4-1-1-6	Date: (of signature which is not contained in the request, or of the declaration that is corrected or added under Rule 26ter after the filing of the international application)	

VIII-4-1-2-1	Name (LAST, First)	HAN, Junming	 2004.12.2
VIII-4-1-2-2	Residence: (city and either US State, if applicable, or country)	Guangdong, China	
VIII-4-1-2-3	Mailing address:	CIMC R&D Center, No. 2 Gangwan Avenue, Shenzhen 518067 Guangdong China Guangdong China	
VIII-4-1-2-4	Citizenship:	CN	
VIII-4-1-2-5	Inventor's Signature: (if not contained in the request, or if declaration is corrected or added under Rule 26ter after the filing of the international application. The signature must be that of the inventor, not that of the agent)		
VIII-4-1-2-6	Date (of signature which is not contained in the request, or of the declaration that is corrected or added under Rule 26ter after the filing of the international application)		
VIII-4-1-3-1	Name (LAST, First)	TAN, Li	 2004.12.02
VIII-4-1-3-2	Residence: (city and either US State, if applicable, or country)	Guangdong, China	
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VIII-4-1-3-5	Inventor's Signature: (if not contained in the request, or if declaration is corrected or added under Rule 26ter after the filing of the international application. The signature must be that of the inventor, not that of the agent)		
VIII-4-1-3-6	Date (of signature which is not contained in the request, or of the declaration that is corrected or added under Rule 26ter after the filing of the international application)		

VIII-4-1-4-1	Name (LAST, First)	BAO, Kun  04.12.2.
VIII-4-1-4-2	Residence: (city and either US State, if applicable, or country)	Guangdong, China
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VIII-4-1-4-4	Citizenship:	CN
VIII-4-1-4-5	Inventor's Signature: (if not contained in the request, or if declaration is corrected or added under Rule 26ter after the filing of the international application. The signature must be that of the inventor, not that of the agent)	
VIII-4-1-4-6	Date (of signature which is not contained in the request, or of the declaration that is corrected or added under Rule 26ter after the filing of the international application)	